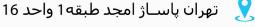






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SLLS114D - JANUARY 1979 - REVISED OCTOBER 1998

- Meets or Exceeds the Requirements of ANSI TIA/EIA-422-B and ITU Recommendation V.11
- Operates From a Single 5-V Supply
- TTL Compatible
- Complementary Outputs
- High Output Impedance in Power-Off Conditions
- Complementary Output-Enable Inputs

D OR N PACKAGE (TOP VIEW) 1A [16 VCC 15 1 4A 1Y **∏**2 1Z **∏** 3 14**∏** 4Y G Π 4 13**∏** 4Z 12 G 2Z **∏** 5 2Y 🛮 6 11 3Z 10 3Y 2A **∏** 7 9 1 3A GND ∏8

description

The AM26LS31C is a quadruple complementary-output line driver designed to meet the requirements of ANSI TIA/EIA-422-B and ITU (formerly CCITT) Recommendation V.11. The 3-state outputs have high-current capability for driving balanced lines such as twisted-pair or parallel-wire transmission lines, and they provide a high-impedance state in the power-off condition. The enable function is common to all four drivers and offers the choice of an active-high or active-low enable (G,\overline{G}) input. Low-power Schottky circuitry reduces power consumption without sacrificing speed.

The AM26LS31C is characterized for operation from 0°C to 70°C.

FUNCTION TABLE (each driver)

INPUT	ENABLES		OUTPUTS			
Α	G	G	Υ	Z		
Н	Н	Х	Н	L		
L	Н	Χ	L	Н		
Н	Х	L	Н	L		
L	Х	L	L	Н		
Х	L	Н	Z	Z		

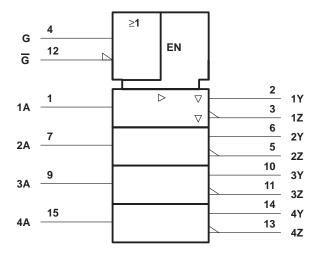
H = high level, L = low level, X = irrelevant, Z = high impedance (off)



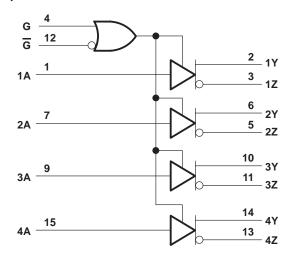
Please be aware that an important notice concerning availability, standard warranty, and use in critical applications of Texas Instruments semiconductor products and disclaimers thereto appears at the end of this data sheet.



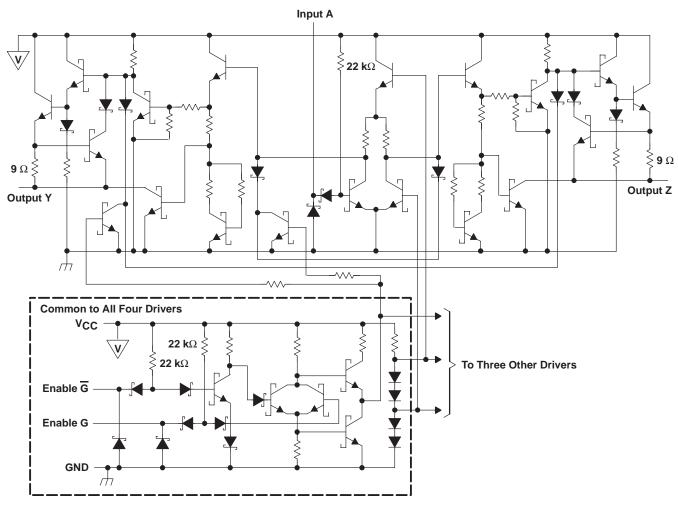
logic symbol†



logic diagram (positive logic)



schematic (each driver)



All resistor values are nominal.

absolute maximum ratings over operating free-air temperature range (unless otherwise noted)

Supply voltage, V _{CC} (see Note 1)	
Input voltage, V _I	
Output off-state voltage	5.5 V
Package thermal impedance, θ_{JA} (see Note 2): D package	113°C/W
N package	78°C/W
Storage temperature range, T _{stq}	–65°C to 150°C
Lead temperature 1.6 mm (1/16 inch) from case for 10 seconds	

[†] Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.



NOTES: 1. All voltage values, except differential output voltage V_{OD}, are with respect to network GND.

^{2.} The package thermal impedance is calculated in accordance with JESD 51, except for through-hole packages, which use a trace length of zero.

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recommended operating conditions (unless otherwise noted)

	MIN	NOM	MAX	UNIT
Supply voltage, V _{CC}	4.75	5	5.25	V
High-level input voltage, VIH	2			V
Low-level input voltage, V _{IL}			0.8	V
High-level output current, IOH			-20	mA
Low-level output current, I _{OL}			20	mA
Operating free-air temperature, T _A	0		70	°C

electrical characteristics over operating free-air temperature range (unless otherwise noted)

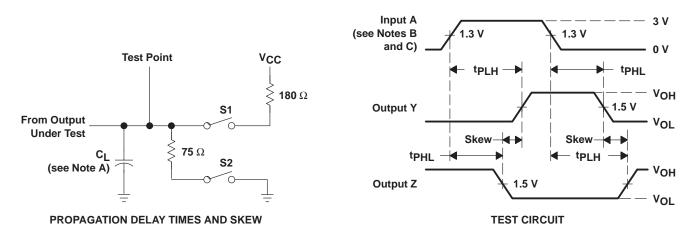
PARAMETER		TEST CONDITIONS		MIN	TYP [†]	MAX	UNIT
VIK	Input clamp voltage	$V_{CC} = 4.75 \text{ V},$	I _I = -18 mA			-1.5	V
Vон	High-level output voltage	$V_{CC} = 4.75 \text{ V},$	$I_{OH} = -20 \text{ mA}$	2.5			V
VOL	Low-level output voltage	$V_{CC} = 4.75 \text{ V},$	$I_{OL} = 20 \text{ mA}$			0.5	V
IOZ Off-state (h	Off-state (high-impedance-state) output current	V _{CC} = 4.75 V	V _O = 0.5 V			-20	
	Oil-state (nigh-impedance-state) output current		V _O = 2.5 V			20	μΑ
П	Input current at maximum input voltage	$V_{CC} = 5.25 \text{ V},$	V _I = 7 V			0.1	mA
lіН	High-level input current	$V_{CC} = 5.25 \text{ V},$	V _I = 2.7 V			20	μΑ
IIL	Low-level input current	$V_{CC} = 5.25 \text{ V},$	V _I = 0.4 V			-0.36	mA
los	Short-circuit output current‡	V _{CC} = 5.25 V	_	-30		-150	mA
ICC	Supply current	$V_{CC} = 5.25 \text{ V},$	All outputs disabled		32	80	mA

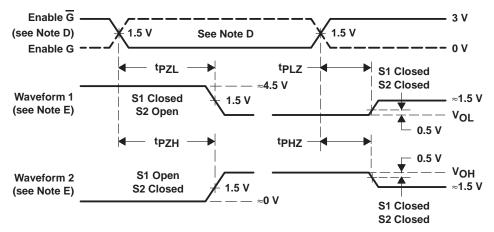
switching characteristics, $V_{CC} = 5 \text{ V}$, $T_A = 25^{\circ}\text{C}$ (see Figure 1)

PARAMETER		TEST CONDITIONS		MIN	TYP	MAX	UNIT
tPLH	Propagation delay time, low-to-high-level output	C _L = 30 pF,	S1 and S2 open		14	20	ns
tPHL	Propagation delay time, high-to-low-level output				14	20	
tPZH	Output enable time to high level	C _L = 30 pF	R _L = 75 Ω		25	40	20
tpzL	Output enable time to low level		R _L = 180 Ω		37	45	ns
tPHZ	Output disable time from high level	C _I = 10 pF,	S1 and S2 closed		21	30	ns
t _{PLZ}	Output disable time from low level	CL = 10 pr,			23	35	115
	Output-to-output skew	$C_L = 30 \text{ pF},$	S1 and S2 open		1	6	ns

[†] All typical values are at V_{CC} = 5 V and T_A = 25°C. ‡ Not more than one output should be shorted at a time, and duration of the short circuit should not exceed one second.

PARAMETER MEASUREMENT INFORMATION





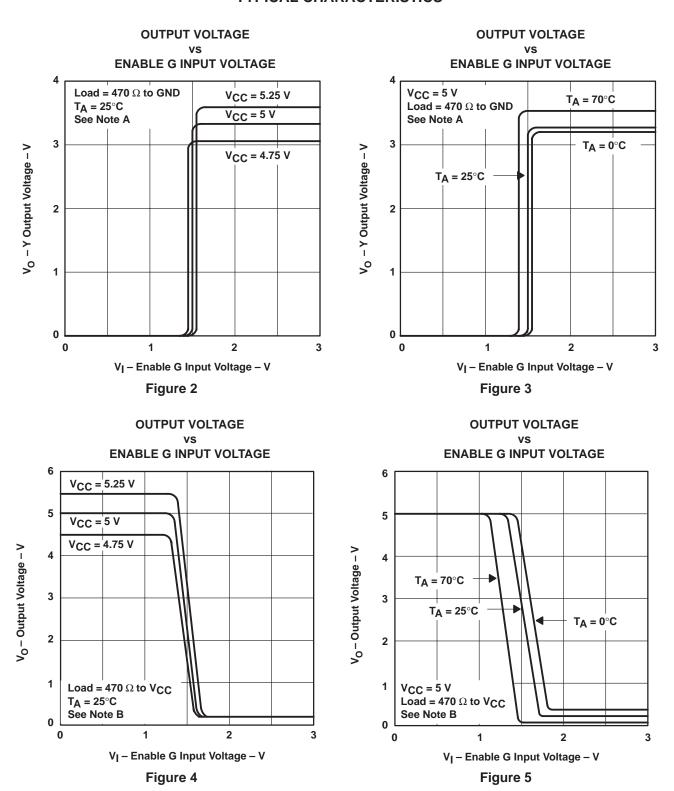
ENABLE AND DISABLE TIME WAVEFORMS

NOTES: A. C_L includes probe and jig capacitance.

- B. All input pulses are supplied by generators having the following characteristics: PRR \leq 1 MHz, $Z_O \approx 50 \Omega$, $t_f \leq 15$ ns, $t_f \leq 6$ ns.
- C. When measuring propagation delay times and skew, switches S1 and S2 are open.
- D. Each enable is tested separately.
- E. Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.

Figure 1. Test Circuit and Voltage Waveforms

TYPICAL CHARACTERISTICS

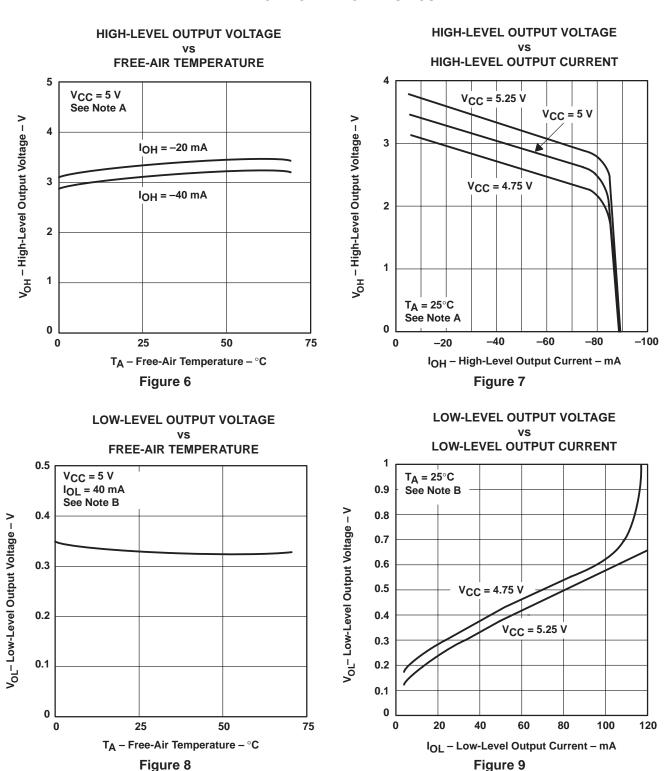


NOTES: A. The A input is connected to V_{CC} during testing of the Y outputs and to ground during testing of the Z outputs.

B. The A input is connected to ground during testing of the Y outputs and to V_{CC} during testing of the Z outputs.



TYPICAL CHARACTERISTICS

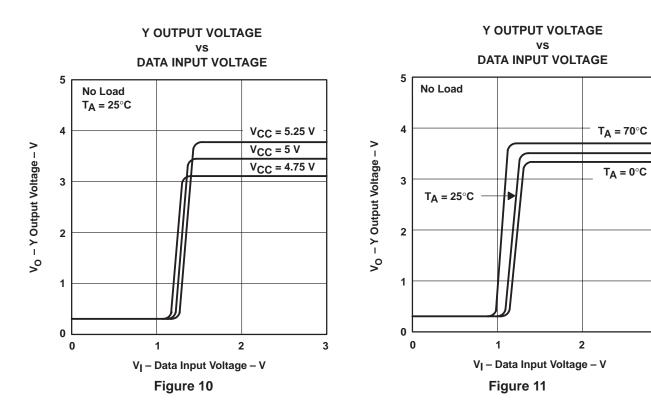


NOTES: A. The A input is connected to VCC during testing of the Y outputs and to ground during testing of the Z outputs.

B. The A input is connected to ground during testing of the Y outputs and to VCC during testing of the Z inputs.



TYPICAL CHARACTERISTICS



3

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